

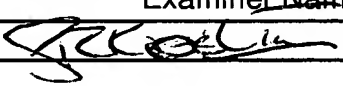

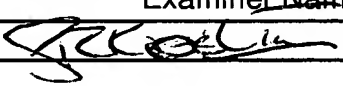

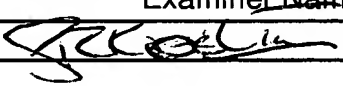


ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18




Stylesheet Version v18.0

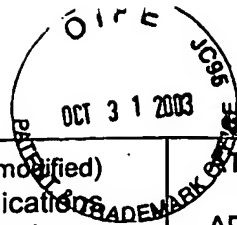
Title of Invention	MULTI-STAGED HEATING SYSTEM FOR FABRICATING MICROELECTRONIC DEVICES																										
<p>Application Number : 10/624397 </p> <p>Confirmation Number: 6816</p> <p>First Named Applicant: Igor Ivanov</p> <p>Attorney Docket Number: 5866-00400</p> <p>Art Unit:</p> <p>Examiner:</p> <p>Search string: (6875691).pn</p> <p>US Patent Documents</p> <p>Note: Applicant is not required to submit a paper copy of cited US Patent Documents</p> <table border="1"><thead><tr><th>init</th><th>Cite.No.</th><th>Patent No.</th><th>Date</th><th>Patentee</th><th>Kind</th><th>Class</th><th>Subclass</th></tr></thead><tbody><tr><td></td><td>1</td><td>6875691</td><td>2005-04-05</td><td>Li et al.</td><td></td><td></td><td></td></tr></tbody></table> <p>Signature</p> <table border="1"><thead><tr><th>Examiner Name</th><th>Date</th></tr></thead><tbody><tr><td></td><td>4/30/06</td></tr></tbody></table>								init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass		1	6875691	2005-04-05	Li et al.				Examiner Name	Date		4/30/06
init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass																				
	1	6875691	2005-04-05	Li et al.																							
Examiner Name	Date																										
	4/30/06																										

ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of Invention	MULTI-STAGED HEATING SYSTEM FOR FABRICATING DEVICES						
Application Number :		10/624397					
Confirmation Number:		6816					
First Named Applicant:		Igor Ivanov					
Attorney Docket Number:		5866-00400					
Art Unit:							
Examiner:							
Search string:		(20030235983).pn					
US Published Applications							
Note: Applicant is not required to submit a paper copy of cited US Published Applications							
init	Cite.No.	Pub. No.	Date	Applicant	Kind	Class	Subclass
	1	20030235983	2003-12-25	Li et al.			
Signature							
Examiner Name				Date			
				4/30/06			

**Form PTO-1449** (modified)List of Patents and Publications
For Applicant's Information
Disclosure Statement
(Use several sheets if necessary)

PATENT DKT. NO. 5866-00400

APPLICANT: Ivanov et al.

FILING DATE: July 22, 2003

SERIAL NO. 10/624,397

GROUP: Unknown

U.S. PATENT DOCUMENTS

EXAM. INITIALS	REF. DES.	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
GRK	A1	5830805	11/1998	Shacham-Diamand et al.	—	—	—
↓	A2	6322677	11/2001	Woodruff et al.	—	—	—

FOREIGN PATENT DOCUMENTS

EXAM. INITIALS	REF. DES.	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUB CLASS	TRANSLATION YES/NO
GRK	A3	WO02/34962	5/2002	WO	—	—	NO

OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)

GRK	A4	Riedel, "Electroless Nickel Plating," 1991, p. 39.
	A5	O'Sullivan et al., "Electrolessly deposited diffusion barriers for microelectronics," IBM Journal of Research and Development, Vol. 42, No. 5, 1998, 20 pages.
	A6	Lopatin et al., "Selective Electroless CoWP Deposition onto Pd-Activated In-Laid Cu Lines," VMIC Conference, 1997, pp. 219-224.
	A7	Shacham-Diamand et al., "High aspect ratio quarter-micron electroless copper integrated technology," Microelectronic Engineering 37/38, 1997, pp. 77-88.
↓	A8	Lantasov et al., "New plating bath for electroless copper deposition on sputtered barrier layers," Microelectronic Engineering 50, 2000, pp. 441-447.

EXAMINER:

DATE CONSIDERED:

4/30/06

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the patent owner.

Information Disclosure Statement--PTO 1449 (modified)

